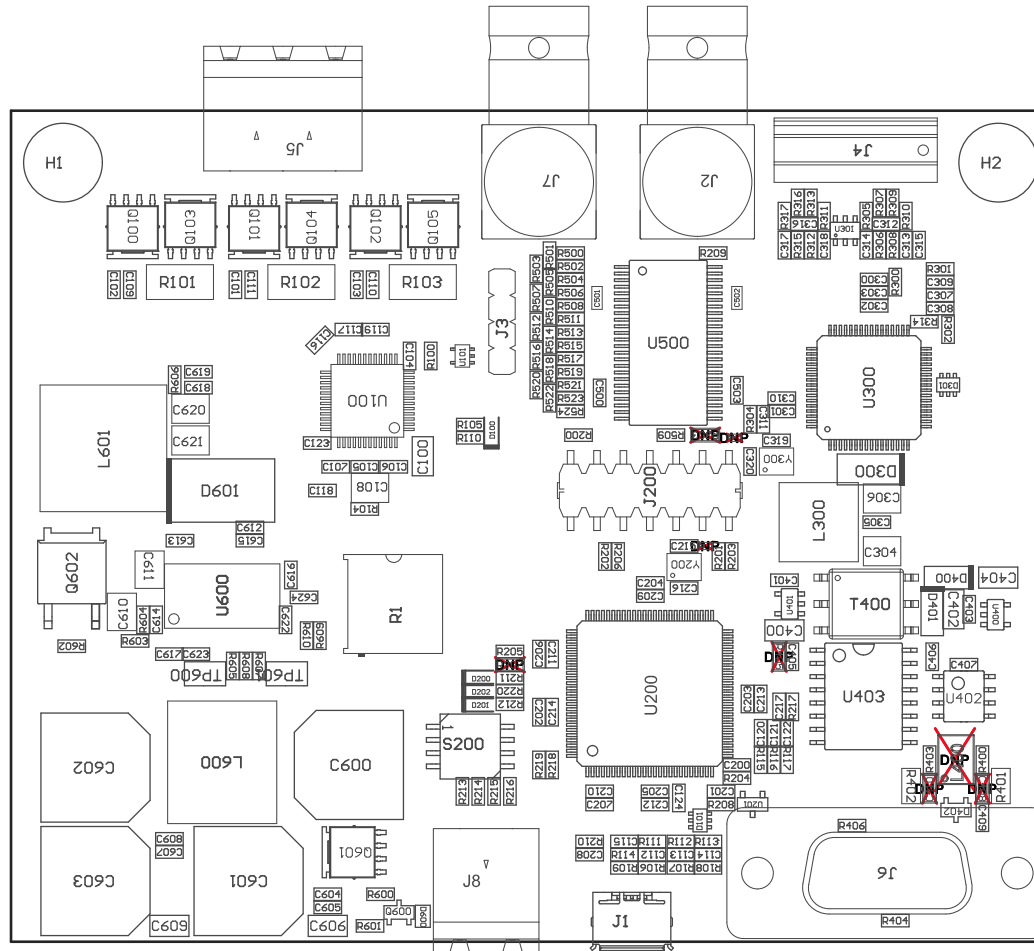
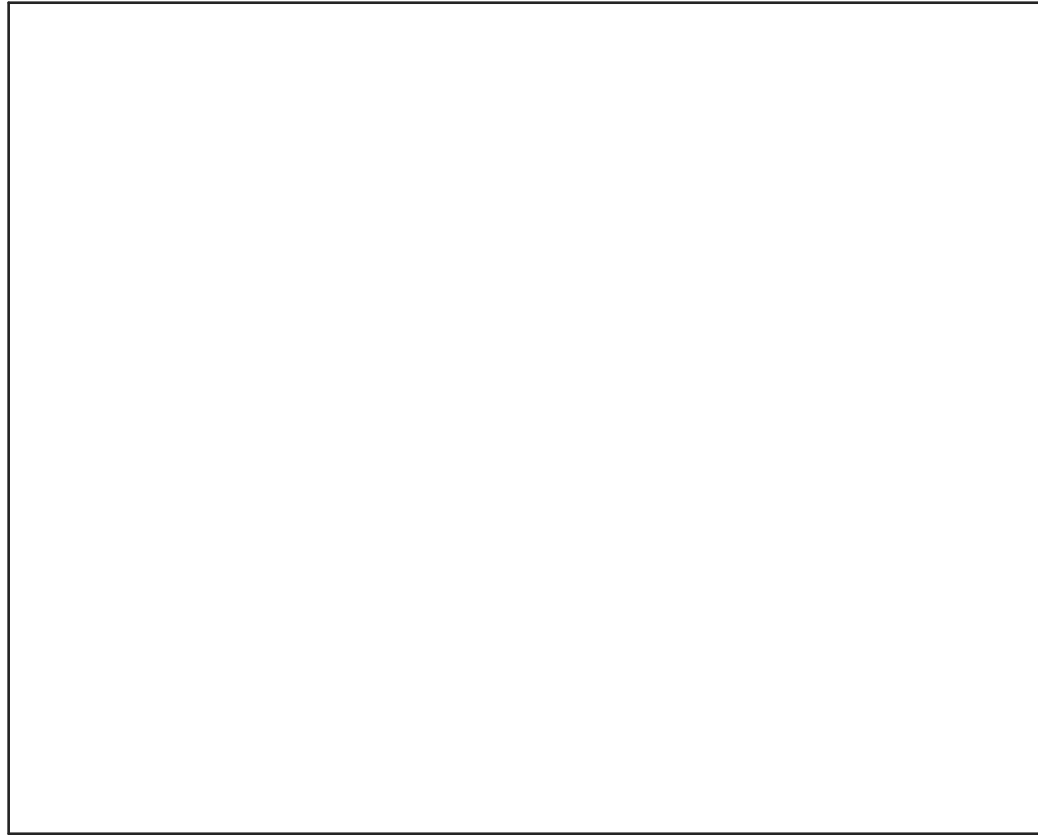


Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font.
 Z22 ■ This Assembly Note will show in the PcbDoc and associated outputs
 Z23 ■ This Assembly Note will show in the PcbDoc and associated outputs
 Z24 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01507	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01507		
PLOT NAME = Top Assembly Drawing	GENERATED : 04-Jul-18	2:56:02 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01507	REV: E1	SVN REV: Not In VersionControl
	TID #: TIDA-01507		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 04-Jul-18	2:56:05 PM	TEXAS INSTRUMENTS

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